

P-channel 20 V, 0.0195 Ω typ., 8 A STripFET™ VII DeepGATE™ Power MOSFET in a PowerFLAT™ 2x2 package

Datasheet - production data

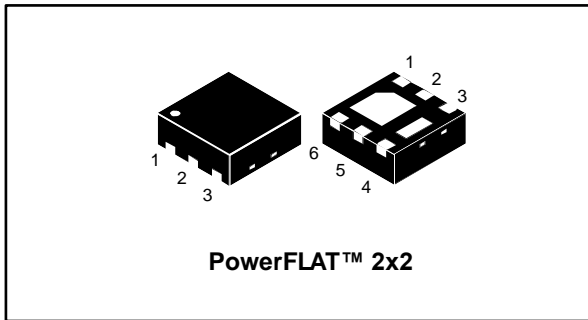
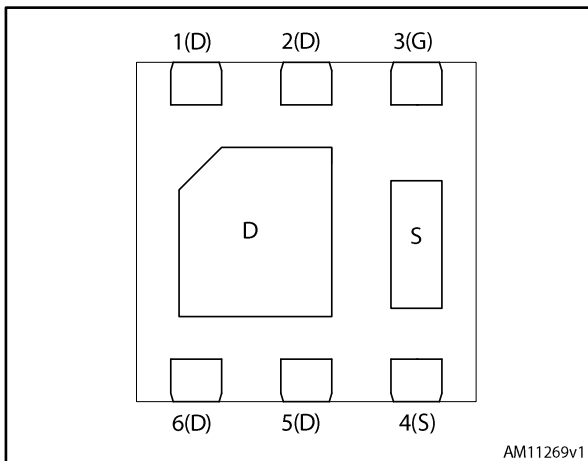


Figure 1: Internal schematic diagram



Features

Order code	V_{DS}	$R_{DS(on)max}$	I_D
STL8P2UH7	20 V	0.0225 Ω @ 4.5 V	8 A

- Extremely low on-resistance $R_{DS(on)}$
- Ultra logic level

Applications


- Switching applications

Description

This device exhibits low on-state resistance and capacitance for improved conduction and switching performance.

Table 1: Device summary

Order code	Marking	Package	Packaging
STL8P2UH7	8L2U	PowerFLAT™ 2x2	Tape and reel

 For the P-channel Power MOSFET the actual polarity of the voltages and the current must be reversed.

Contents

1	Electrical ratings	3
2	Electrical characteristics	4
	2.1 Electrical characteristics (curves)	6
3	Test circuits	8
4	Package mechanical data	9
	4.1 PowerFLAT™ 2x2 package mechanical data	10
5	Revision history	13

1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{DS}	Drain-source voltage	20	V
V_{GS}	Gate-source voltage	± 8	V
I_D	Drain current (continuous) at $T_{pcb}= 25\text{ }^\circ\text{C}$	8	A
I_D	Drain current (continuous) at $T_{pcb}= 100\text{ }^\circ\text{C}$	5.3	A
$I_{DM}^{(1)}$	Drain current (pulsed)	32	A
P_{TOT}	Total dissipation at $T_{pcb}= 25\text{ }^\circ\text{C}$	2.4	W
T_{stg}	Storage temperature	- 55 to 150	$^\circ\text{C}$
T_j	Max. operating junction temperature	150	$^\circ\text{C}$

Notes:

⁽¹⁾Pulse width limited by safe operating area

Table 3: Thermal data

Symbol	Parameter	Value	Unit
$R_{thj-pcb}^{(1)}$	Thermal resistance junction-pcb max	52	$^\circ\text{C/W}$

Notes:

⁽¹⁾When mounted on 1inch² FR-4 board, 2 oz Cu



For the P-channel Power MOSFET the actual polarity of the voltages and the current must be reversed.

2 Electrical characteristics

($T_C = 25\text{ °C}$ unless otherwise specified)

Table 4: On /off states

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0, I_D = 250\text{ }\mu\text{A}$	20			V
I_{DSS}	Zero gate voltage drain current	$V_{GS} = 0, V_{DS} = 20\text{ V}$			1	μA
I_{GSS}	Gate-body leakage current	$V_{DS} = 0, V_{GS} = \pm 5\text{ V}$			± 5	μA
$V_{GS(th)}$	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 250\text{ }\mu\text{A}$	0.4		1	V
$R_{DS(on)}$	Static drain-source on- resistance	$V_{GS} = 4.5\text{ V}, I_D = 4\text{ A}$		0.0195	0.0225	Ω
		$V_{GS} = 2.5\text{ V}, I_D = 4\text{ A}$		0.02	0.025	Ω
		$V_{GS} = 1.8\text{ V}, I_D = 4\text{ A}$		0.036	0.043	Ω
		$V_{GS} = 1.5\text{ V}, I_D = 4\text{ A}$		0.05	0.085	Ω

Table 5: Dynamic

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
C_{iss}	Input capacitance	$V_{GS} = 0, V_{DS} = 16\text{ V},$ $f = 1\text{ MHz}$	-	2390	-	pF
C_{oss}	Output capacitance		-	220	-	pF
C_{rss}	Reverse transfer capacitance		-	188	-	pF
Q_g	Total gate charge	$V_{DD} = 16\text{ V}, I_D = 8\text{ A},$ $V_{GS} = 4.5\text{ V}$	-	22	-	nC
Q_{gs}	Gate-source charge		-	4.2	-	nC
Q_{gd}	Gate-drain charge		-	3.6	-	nC



For the P-channel Power MOSFET the actual polarity of the voltages and the current must be reversed.

Table 6: Switching times

Symbol	Parameter	Test conditions	Min.	Typ.	Max	Unit
$t_{d(on)}$	Turn-on delay time	$V_{DD} = 16\text{ V}, I_D = 8\text{ A},$ $R_G = 1\text{ }\Omega, V_{GS} = 4.5\text{ V}$	-	12.5	-	ns
t_r	Rise time		-	30.5	-	ns
$t_{d(off)}$	Turn-off delay time		-	128	-	ns
t_f	Fall time		-	84.5	-	ns

Table 7: Source drain diode

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
I_{SD}	Source-drain current		-		8	A
$I_{SDM}^{(1)}$	Source-drain current (pulsed)		-		32	A
$V_{SD}^{(2)}$	Forward on voltage	$V_{GS}=0, I_{SD}=1\text{ A}$	-		1	V
t_{rr}	Reverse recovery time	$V_{DD}=16\text{ V}$ $di/dt = 100\text{ A}/\mu\text{s}$, $I_{SD}=1\text{ A}$	-	15.8		ns
Q_{rr}	Reverse recovery charge		-	5.9		nC
I_{RRM}	Reverse recovery current		-	0.7		A

Notes:

⁽¹⁾Pulse width limited by safe operating area.

⁽²⁾Pulsed: pulse duration = 300 μs , duty cycle 1.5%



For the P-channel Power MOSFET the actual polarity of the voltages and the current must be reversed.

2.1 Electrical characteristics (curves)

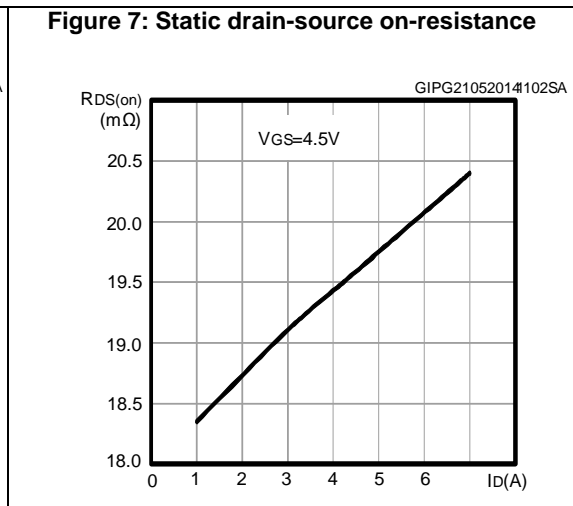
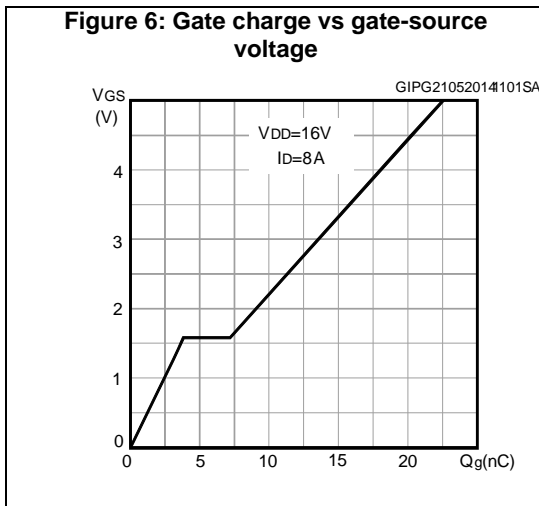
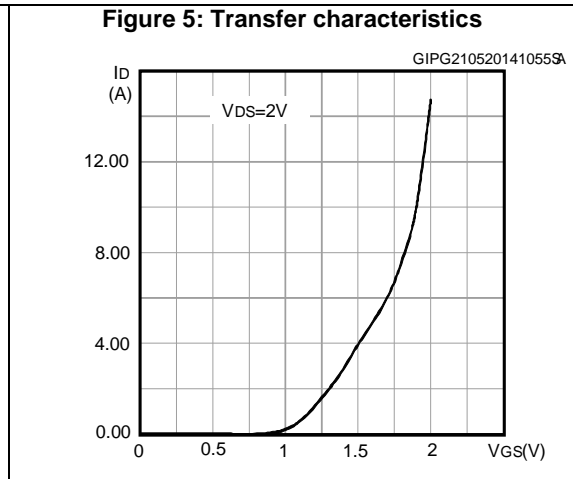
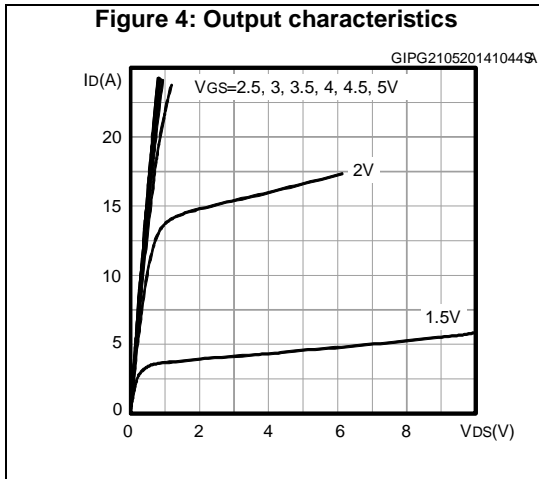
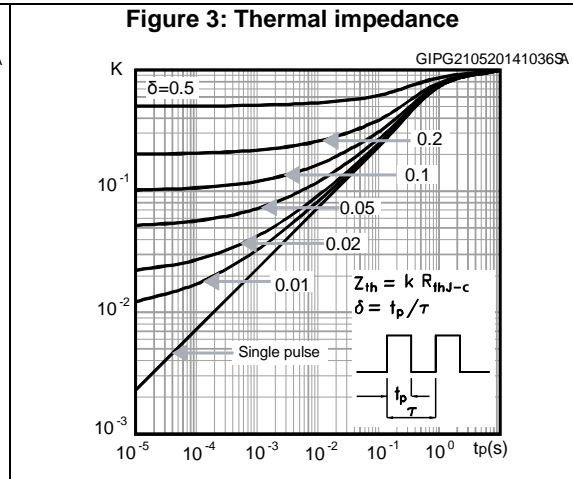
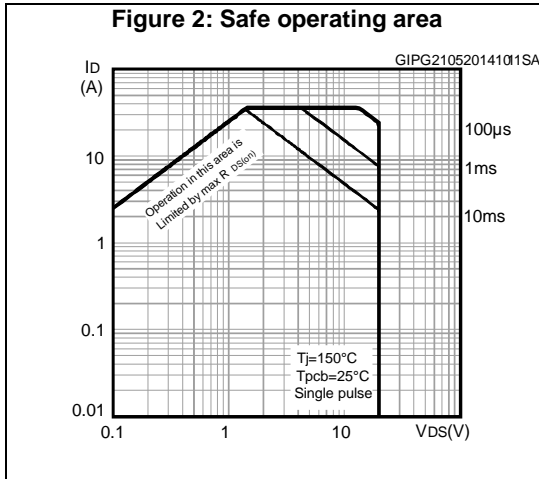


Figure 8: Capacitance variations

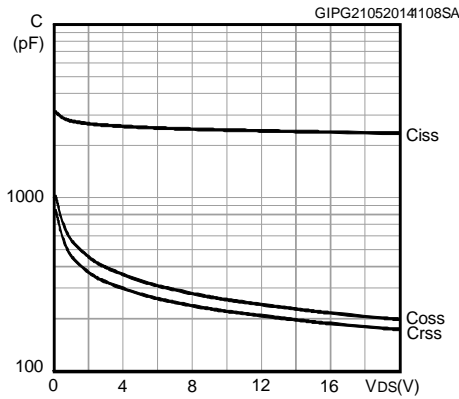


Figure 9: Normalized gate threshold voltage vs temperature

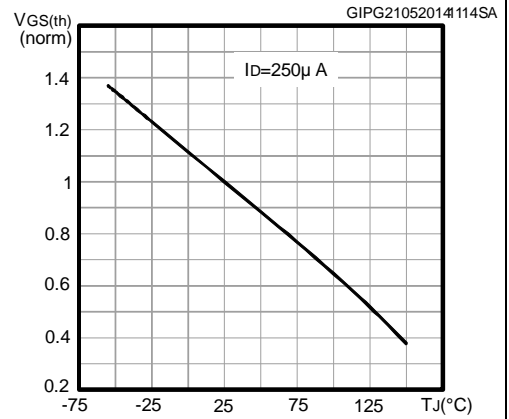


Figure 10: Normalized on-resistance vs temperature

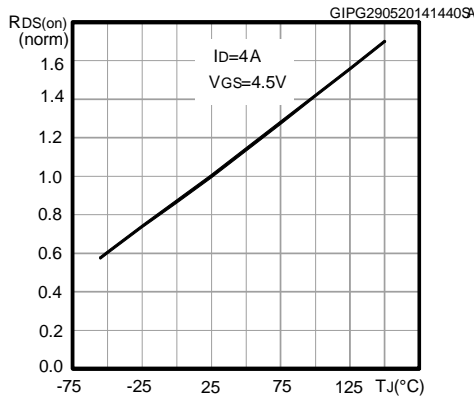


Figure 11: Normalized V(BR)DSS vs temperature

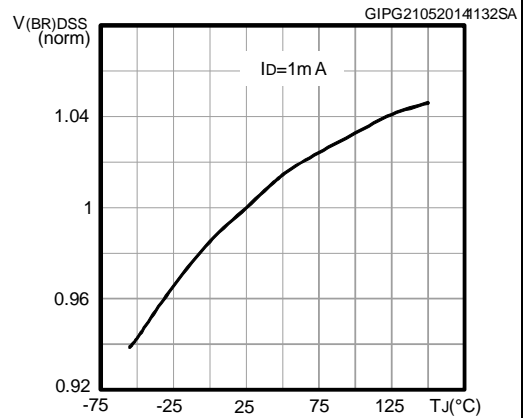
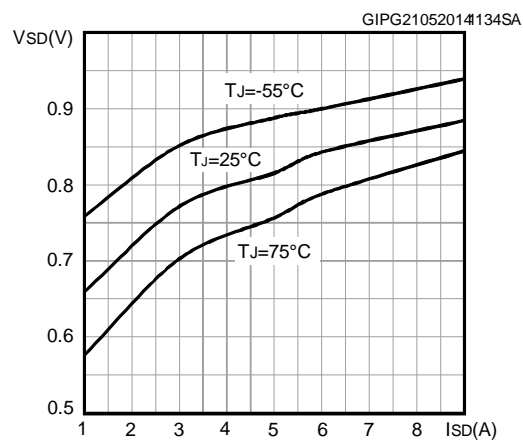


Figure 12: Source-drain diode forward characteristics



3 Test circuits

Figure 13: Switching times test circuit for resistive load

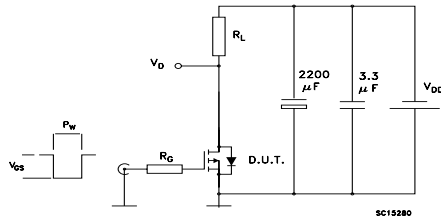


Figure 14: Gate charge test circuit

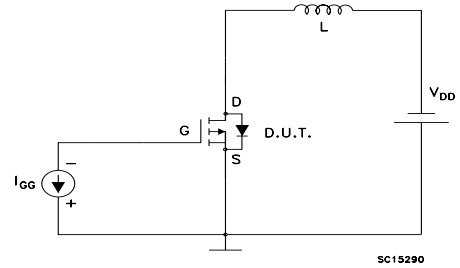
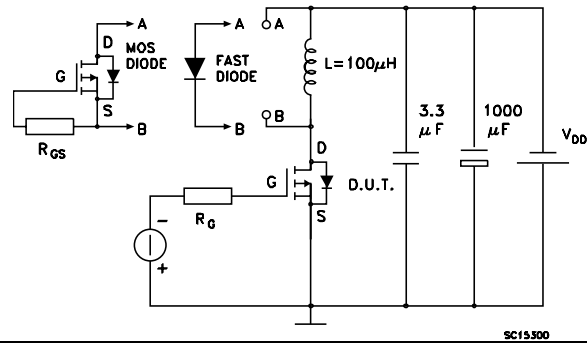


Figure 15: Test circuit for inductive load switching and diode recovery times



4 Package mechanical data

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4.1 PowerFLAT™ 2x2 package mechanical data

Figure 16: Drawing dimension PowerFLAT™ 2 x 2

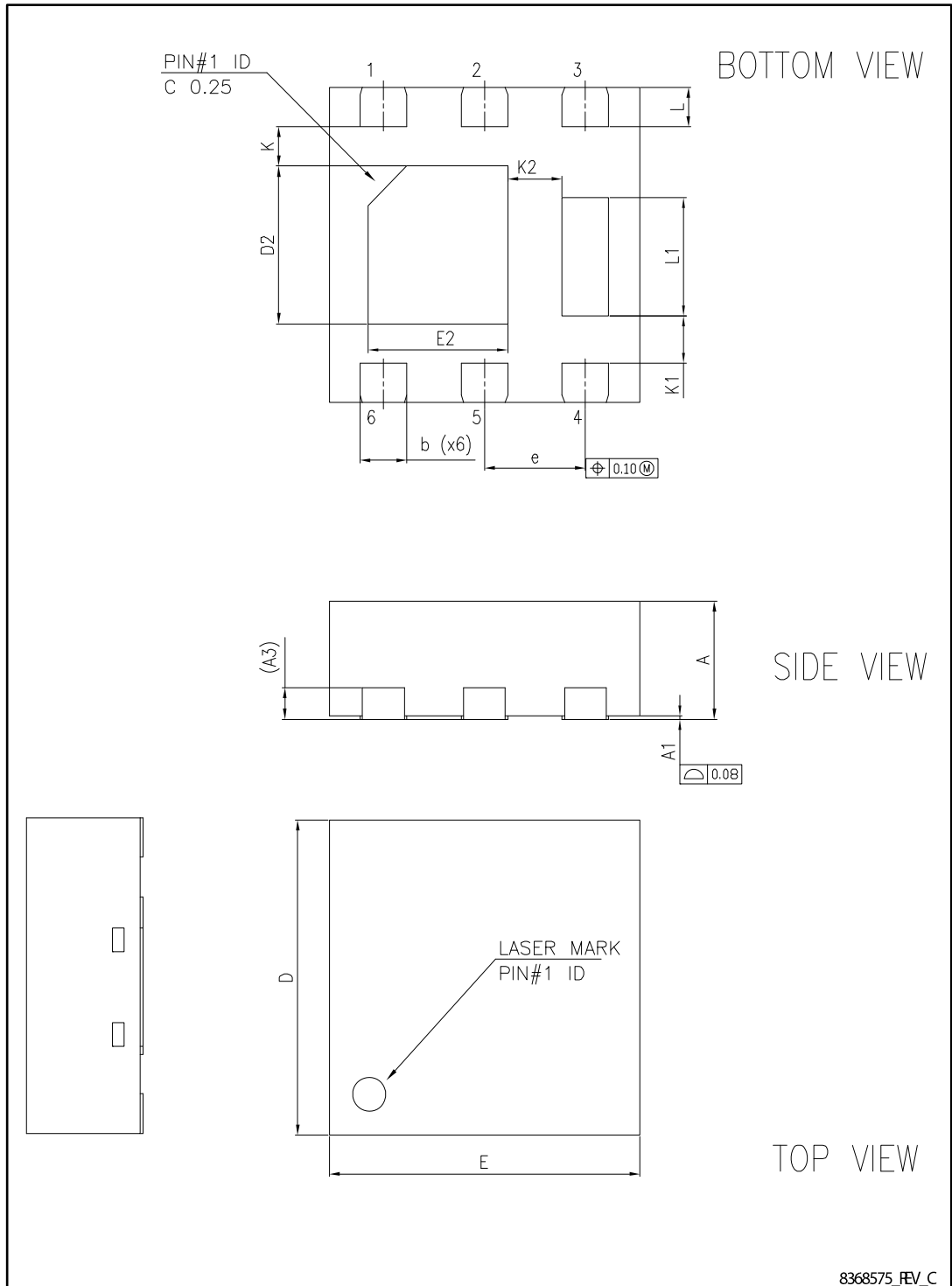


Table 8: PowerFLAT™ 2 x 2 mechanical data

Dim.	mm.		
	Min.	Typ.	Max.
A	0.70	0.75	0.80
A1	0.00	0.02	0.05
A3		0.20	
b	0.25	0.30	0.35
D	1.90	2.00	2.10
E	1.90	2.00	2.10
D2	0.90	1.00	1.10
E2	0.80	0.90	1.00
e	0.55	0.65	0.75
K	0.15	0.25	0.35
K1	0.20	0.30	0.40
K2	0.25	0.35	0.45
L	0.20	0.25	0.30
L1	0.65	0.75	0.85

5 Revision history

Table 9: Document revision history

Date	Revision	Changes
20-Aug-2013	1	First release.
04-Jun-2014	2	Document status promoted from preliminary data to production data Modified: title Modified: $R_{DS(on)}$ max value in cover page Modified: $R_{DS(on)}$ (typical and maximum) values in Table 4: "On /off states" Modified: the entire typical values in Table 5: "Dynamic" , Table 6: "Switching times" and Table 7: "Source drain diode" Added Section 8.1: "Electrical characteristics (curves)" Minor text changes

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